

# High Efficiency Standard Rectifier

|           |   |        |
|-----------|---|--------|
| $V_{RRM}$ | = | 800 V  |
| $I_{FAV}$ | = | 40 A   |
| $V_F$     | = | 1.26 V |

## Single Diode

### Part number

**DLA40IM800PC**

Marking on Product: *DLA40IM800PC*



Backside: cathode



### Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very low forward voltage drop
- Improved thermal behaviour

### Applications:

- Diode for main rectification
- For single and three phase bridge configurations

### Package: TO-263 (D2Pak)

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

### Disclaimer Notice

Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at [www.littelfuse.com/disclaimer-electronics](http://www.littelfuse.com/disclaimer-electronics).

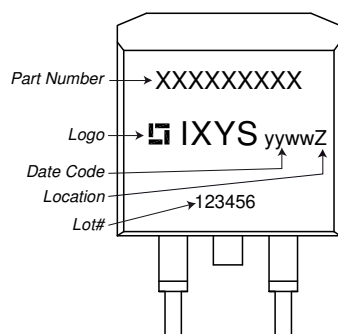
| Rectifier  |  |   |                              | Ratings |      |               |                  |
|------------|--|---|------------------------------|---------|------|---------------|------------------|
| Symbol     | Definition                                   | Conditions  | min.                         | typ.    | max. | Unit          |                  |
| $V_{RSM}$  | max. non-repetitive reverse blocking voltage |   |                              |         | 900  | V             |                  |
| $V_{RRM}$  | max. repetitive reverse blocking voltage     |   |                              |         | 800  | V             |                  |
| $I_R$      | reverse current                              | $V_R = 800\text{ V}$                              |                              |         | 10   | $\mu\text{A}$ |                  |
|            |  | $V_R = 800\text{ V}$                              |                              |         | 0.05 | mA            |                  |
| $V_F$      | forward voltage drop                         | $I_F = 40\text{ A}$                               |                              |         | 1.30 | V             |                  |
|            |  | $I_F = 80\text{ A}$                               |                              |         | 1.56 | V             |                  |
|            |  | $I_F = 40\text{ A}$                               | $T_{VJ} = 150^\circ\text{C}$ |         |      | 1.26          | V                |
|            |  | $I_F = 80\text{ A}$                               | $T_{VJ} = 150^\circ\text{C}$ |         |      | 1.65          | V                |
| $I_{FAV}$  | average forward current                      | $T_C = 120^\circ\text{C}$<br>rectangular          |                              |         | 40   | A             |                  |
| $V_{F0}$   | threshold voltage                            | } for power loss calculation only                 |                              |         | 0.85 | V             |                  |
| $r_F$      | slope resistance                             |   |                              |         | 10   | m $\Omega$    |                  |
| $R_{thJC}$ | thermal resistance junction to case          |   |                              |         | 0.8  | K/W           |                  |
| $R_{thCH}$ | thermal resistance case to heatsink          |   |                              | 0.25    |      | K/W           |                  |
| $P_{tot}$  | total power dissipation                      |   |                              |         | 185  | W             |                  |
| $I_{FSM}$  | max. forward surge current                   | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 45^\circ\text{C}$  |         |      | 300           | A                |
|            |  | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | $V_R = 0\text{ V}$           |         |      | 325           | A                |
|            |  | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 150^\circ\text{C}$ |         |      | 255           | A                |
|            |  | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | $V_R = 0\text{ V}$           |         |      | 275           | A                |
| $I^2t$     | value for fusing                             | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 45^\circ\text{C}$  |         |      | 450           | A <sup>2</sup> s |
|            |  | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | $V_R = 0\text{ V}$           |         |      | 440           | A <sup>2</sup> s |
|            |  | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 150^\circ\text{C}$ |         |      | 325           | A <sup>2</sup> s |
|            |  | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | $V_R = 0\text{ V}$           |         |      | 315           | A <sup>2</sup> s |
| $C_J$      | junction capacitance                         | $V_R = 400\text{ V}; f = 1\text{ MHz}$            | $T_{VJ} = 25^\circ\text{C}$  |         | 10   | pF            |                  |



| Package TO-263 (D2Pak) |                              |                            | Ratings |      |      |      |
|------------------------|------------------------------|----------------------------|---------|------|------|------|
| Symbol                 | Definition                   | Conditions                 | min.    | typ. | max. | Unit |
| $I_{RMS}$              | RMS current                  | per terminal <sup>1)</sup> |         |      | 35   | A    |
| $T_{VJ}$               | virtual junction temperature |                            | -55     |      | 175  | °C   |
| $T_{op}$               | operation temperature        |                            | -55     |      | 150  | °C   |
| $T_{stg}$              | storage temperature          |                            | -55     |      | 150  | °C   |
| <b>Weight</b>          |                              |                            |         | 1.5  |      | g    |
| $F_C$                  | mounting force with clip     |                            | 20      |      | 60   | N    |

<sup>1)</sup>  $I_{RMS}$  is typically limited by the pin-to-chip resistance (1); or by the current capability of the chip (2). In case of (1) and a product with multiple pins for one chip-potential, the current capability can be increased by connecting the pins as one contact.

**Product Marking**



**Part description**

- D = Diode
- L = Low Voltage Standard Rectifier
- A = (up to 1200V)
- 40 = Current Rating [A]
- IM = Single Diode
- 800 = Reverse Voltage [V]
- PC = TO-263AB (D2Pak) (2)

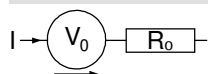
| Ordering    | Ordering Number  | Marking on Product | Delivery Mode | Quantity | Code No. |
|-------------|------------------|--------------------|---------------|----------|----------|
| Standard    | DLA40IM800PC-TRL | DLA40IM800PC       | Tape & Reel   | 800      | 509995   |
| Alternative | DLA40IM800PC-TUB | DLA40IM800PC       | Tube          | 50       | 525085   |

| Similar Part | Package              | Voltage class |
|--------------|----------------------|---------------|
| DSI30-08AS   | TO-263AB (D2Pak) (2) | 800           |
| DSI30-12AS   | TO-263AB (D2Pak) (2) | 1200          |
| DSI30-16AS   | TO-263AB (D2Pak) (2) | 1600          |

**Equivalent Circuits for Simulation**

*\* on die level*

$T_{VJ} = 175^{\circ}C$



**Rectifier**

|              |                    |      |    |
|--------------|--------------------|------|----|
| $V_{0\ max}$ | threshold voltage  | 0.85 | V  |
| $R_{0\ max}$ | slope resistance * | 6.8  | mΩ |

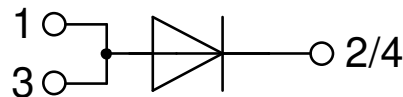


**Outlines TO-263 (D2Pak)**



| Dim. | Millimeter |       | Inches      |       |
|------|------------|-------|-------------|-------|
|      | min        | max   | min         | max   |
| A    | 4.06       | 4.83  | 0.160       | 0.190 |
| A1   | typ. 0.10  |       | typ. 0.004  |       |
| A2   | 2.41       |       | 0.095       |       |
| b    | 0.51       | 0.99  | 0.020       | 0.039 |
| b2   | 1.14       | 1.40  | 0.045       | 0.055 |
| c    | 0.40       | 0.74  | 0.016       | 0.029 |
| c2   | 1.14       | 1.40  | 0.045       | 0.055 |
| D    | 8.38       | 9.40  | 0.330       | 0.370 |
| D1   | 8.00       | 8.89  | 0.315       | 0.350 |
| D2   | 2.5        |       | 0.098       |       |
| E    | 9.65       | 10.41 | 0.380       | 0.410 |
| E1   | 6.22       | 8.50  | 0.245       | 0.335 |
| e    | 2.54 BSC   |       | 0.100 BSC   |       |
| e1   | 4.28       |       | 0.169       |       |
| H    | 14.61      | 15.88 | 0.575       | 0.625 |
| L    | 1.78       | 2.79  | 0.070       | 0.110 |
| L1   | 1.02       | 1.68  | 0.040       | 0.066 |
| W    | typ. 0.02  | 0.040 | typ. 0.0008 | 0.002 |

*All dimensions conform with and/or within JEDEC standard.*



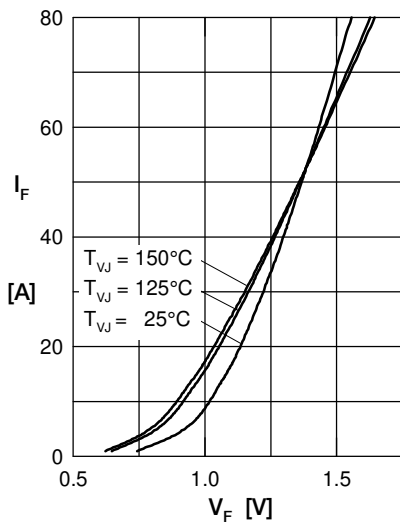
**Rectifier**


Fig. 1 Forward current versus voltage drop

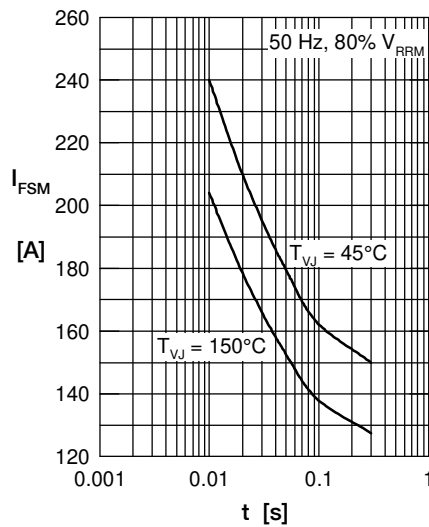


Fig. 2 Surge overload current

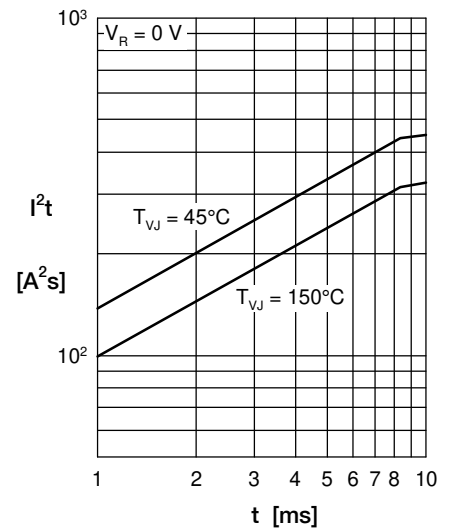
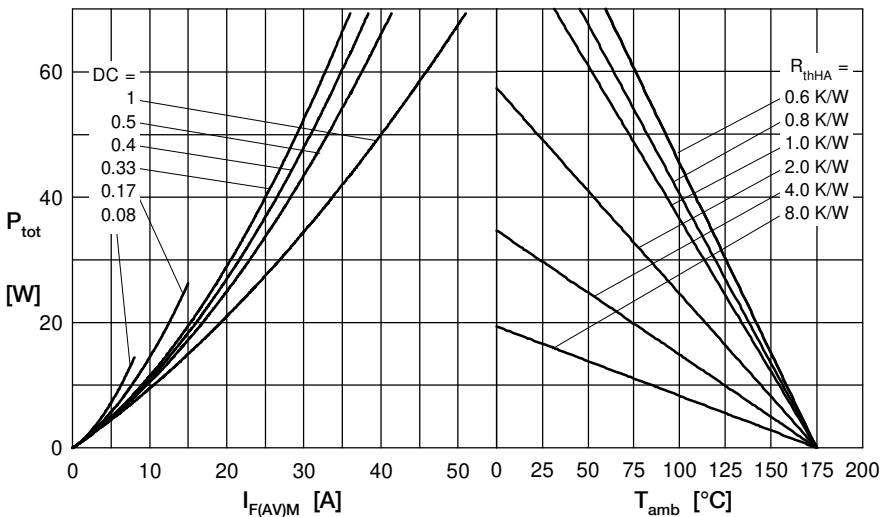

 Fig. 3  $I^2t$  versus time


Fig. 4 Power dissipation versus direct output current and ambient temperature

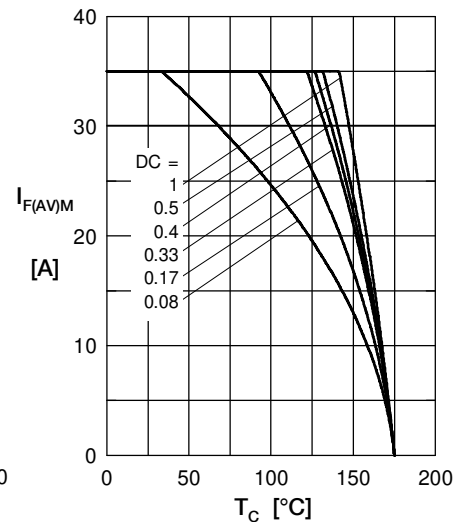


Fig. 5 Max. forward current vs. case temperature

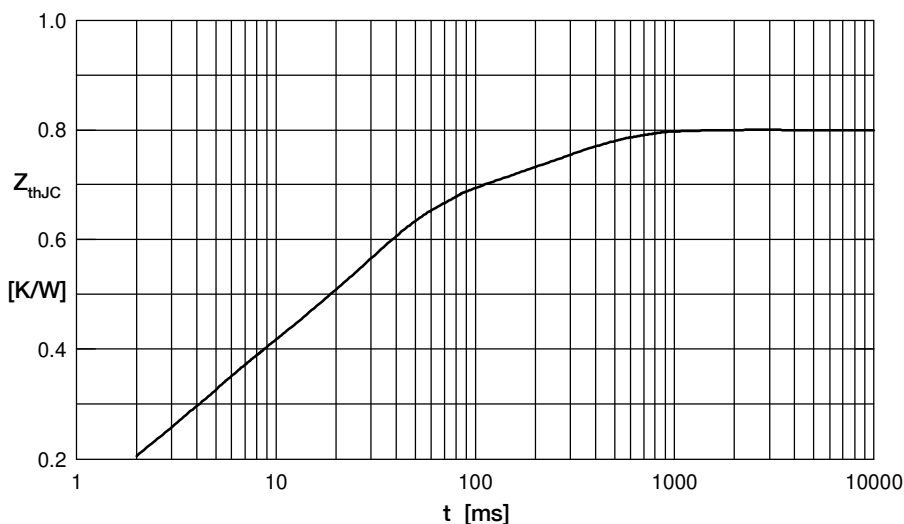


Fig. 6 Transient thermal impedance junction to case

 Constants for  $Z_{thJC}$  calculation:

| i | $R_{thi}$ (K/W) | $t_i$ (s) |
|---|-----------------|-----------|
| 1 | 0.04            | 0.0004    |
| 2 | 0.07            | 0.002     |
| 3 | 0.19            | 0.003     |
| 4 | 0.35            | 0.024     |
| 5 | 0.15            | 0.25      |